



2.7 inch E-paper Display Series



GDEY027T91-T01

Dalian Good Display Co., Ltd.

Product Specifications

Customer	Standard
Description	2.7" E-PAPER DISPLAY
Model Name	GDEY027T91-T01
Date	2022/10/10
Revision	1.0

	Design Engineering		
	Approval	Check	Design
			

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REVISION HISTORY

Rev	Date	Item	Page	Remark
1.0	Oct.10.2022	New Creation	ALL	

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1. Over View

GDEY027T91-T01 is an Active Matrix Electrophoretic Display (AM EPD), with interface and a reference system design. The display is capable to display image at 1-bit white, black full display capabilities. The 2.7inch active area contains 264×176 pixels. The module is a TFT-array driving electrophoresis display, with integrated circuits including gate driver, source driver, MCU interface, timing controller, oscillator, DC-DC, SRAM, LUT , VCOM. Module can be used in portable electronic devices, such as Electronic Shelf Label (ESL) System.

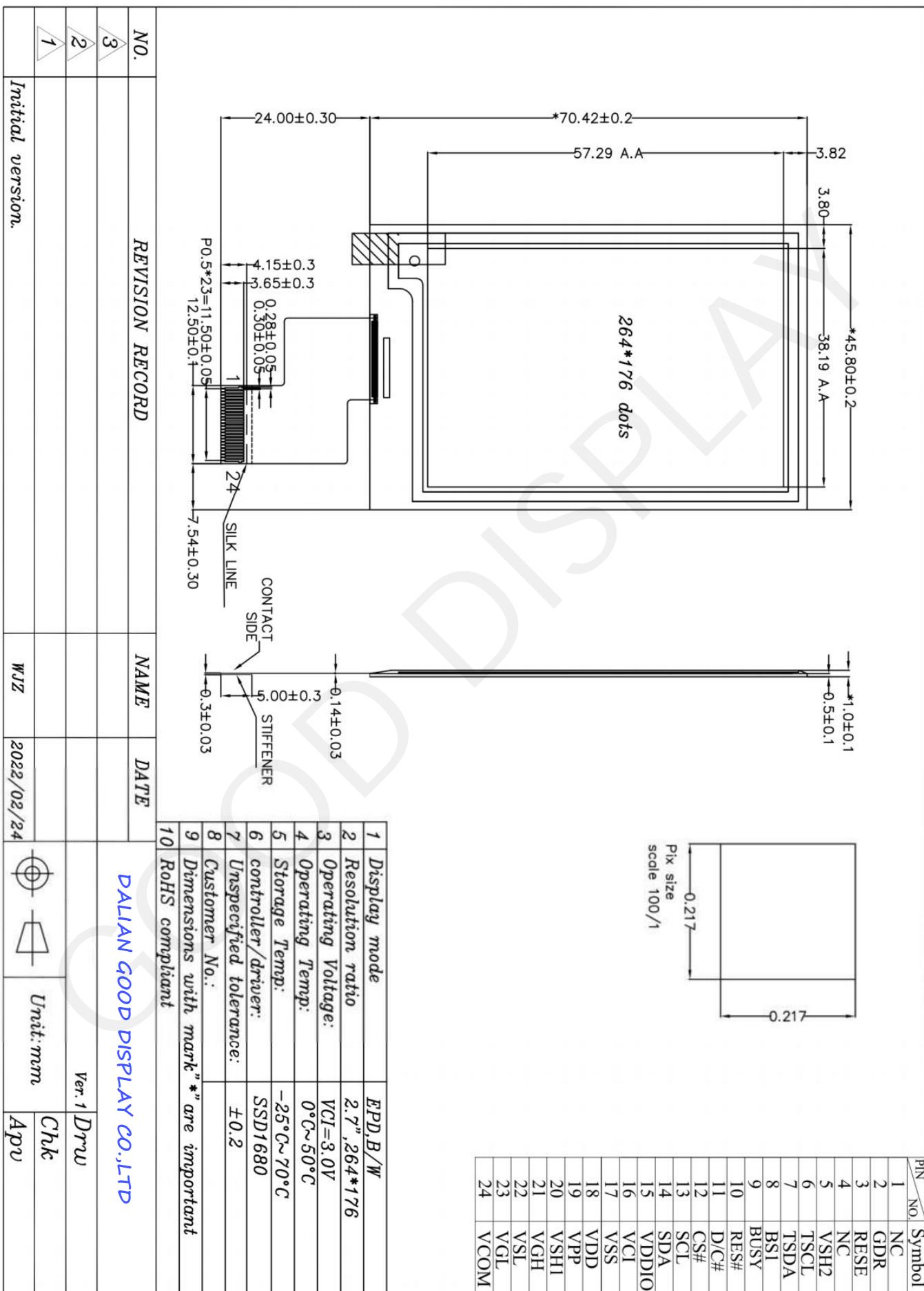
2. Features

264×176 pixels display with touchscreen
High contrast High reflectance
Ultra wide viewing angle Ultra low power consumption
Pure reflective mode
Bi-stable display
Commercial temperature range
Landscape portrait modes
Hard-coat antiglare display surface
Ultra Low current deep sleep mode
On chip display RAM
Waveform can stored in On-chip OTP or written by MCU
Serial peripheral interface available
On-chip oscillator
On-chip booster and regulator control for generating VCOM, Gate and Source driving voltage
I2C signal master interface to read external temperature sensor
Built-in temperature sensor

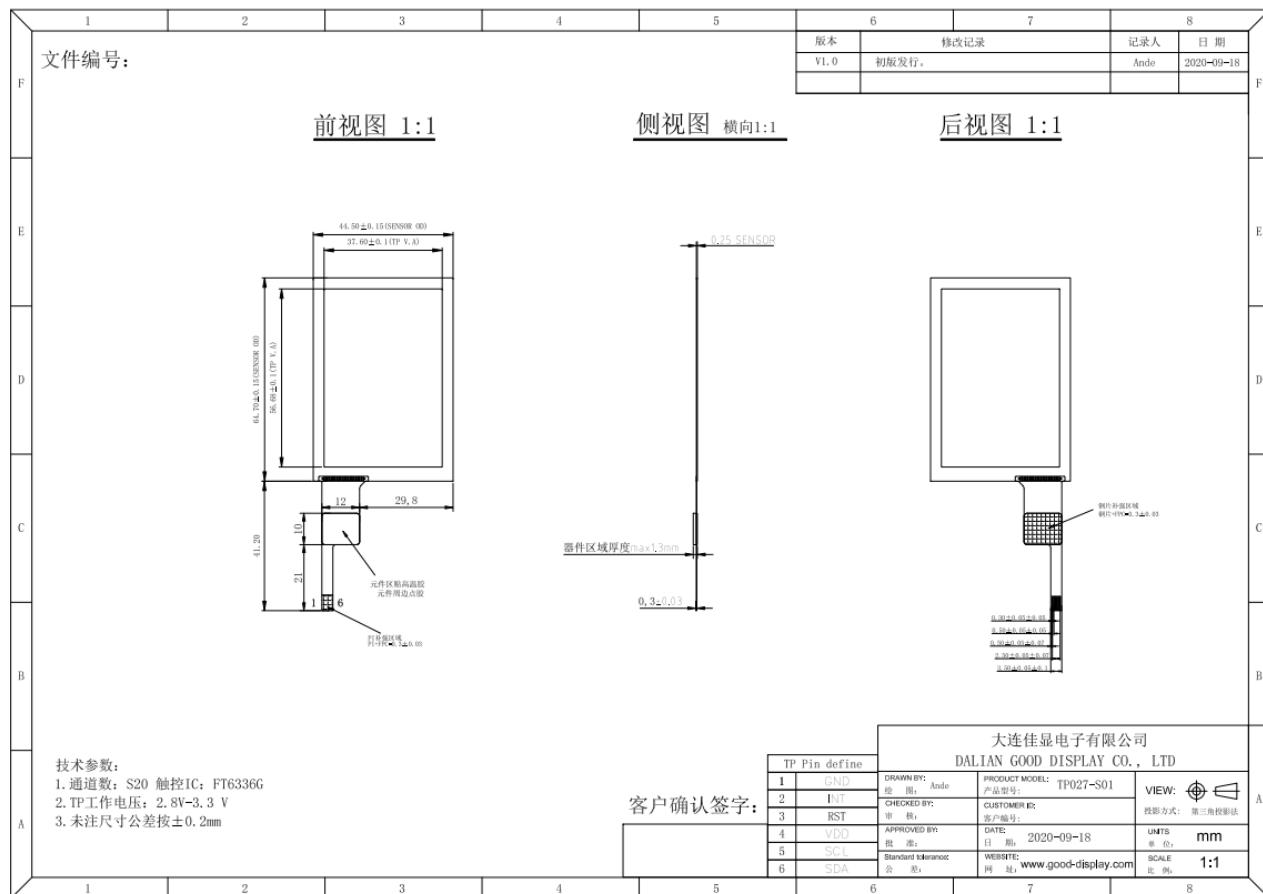
3. Mechanical Specifications

Parameter	Specifications	Unit	Remark
Screen Size	2.7	Inch	
Display Resolution	$264(H) \times 176(V)$	Pixel	Dpi:117
Active Area	38.19×57.29	mm	
Pixel Pitch	0.217×0.217	mm	
Pixel Configuration	Rectangle		
Outline Dimension	$45.8(H) \times 70.42(V) \times 1.23(D)$	mm	
Weight	TBD	g	

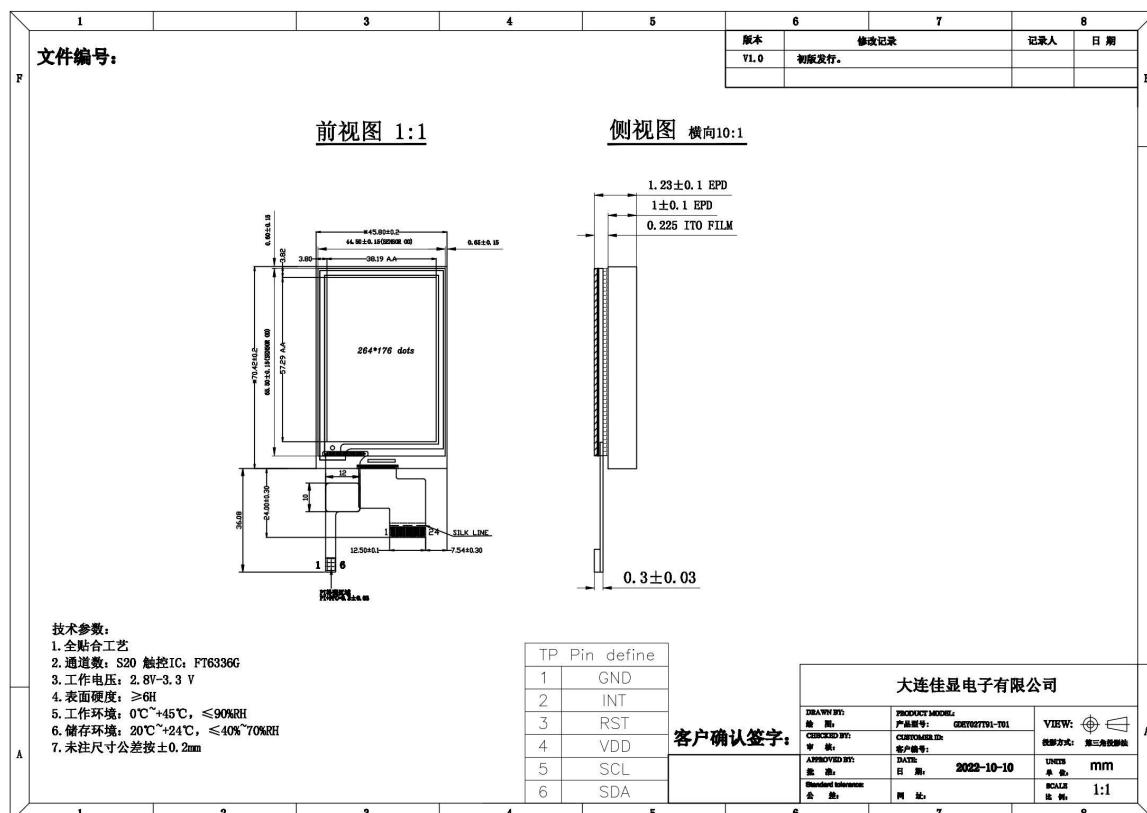
4. Mechanical Drawing of EPD module



4.1 Mechanical Drawing of TP027-S01



4.2 Mechanical Drawing of GDEY027T91-T01



5. Input /Output Pin Assignment

No.	Name	I/O	Description	Remark
1	NC		Do not connect with other NC pins	Keep Open
2	GDR	O	N-Channel MOSFET Gate Drive Control	
3	RESE	I	Current Sense Input for the Control Loop	
4	NC	NC	Do not connect with other NC pins	Keep Open
5	VSH2	C	Positive Source driving voltage(Red)	
6	TSCL	O	I ² C Interface to digital temperature sensor Clock pin	
7	TSDA	I/O	I ² C Interface to digital temperature sensor Data pin	
8	BS1	I	Bus Interface selection pin	Note 5-5
9	BUSY	O	Busy state output pin	Note 5-4
10	RES#	I	Reset signal input. Active Low.	Note 5-3
11	D/C#	I	Data /Command control pin	Note 5-2
12	CS#	I	Chip select input pin	Note 5-1
13	SCL	I	Serial Clock pin (SPI)	
14	SDA	I	Serial Data pin (SPI)	
15	VDDIO	P	Power Supply for interface logic pins It should be connected with VCI	
16	VCI	P	Power Supply for the chip	
17	VSS	P	Ground	
18	VDD	C	Core logic power pin VDD can be regulated internally from VCI. A capacitor should be connected between VDD and VSS	
19	VPP	P	FOR TEST	
20	VSH1	C	Positive Source driving voltage	
21	VGH	C	Power Supply pin for Positive Gate driving voltage and VSH1	
22	VSL	C	Negative Source driving voltage	
23	VGL	C	Power Supply pin for Negative Gate driving voltage VCOM and VSL	
24	VCOM	C	VCOM driving voltage	

I = Input Pin, O =Output Pin, I/O = Bi-directional Pin (Input/output), P = Power Pin, C = Capacitor Pin

Note 5-1: This pin (CS#) is the chip select input connecting to the MCU. The chip is enabled for MCU communication only when CS# is pulled LOW.

Note 5-2: This pin is (D/C#) Data/Command control pin connecting to the MCU in 4-wire SPI mode. When the pin is pulled HIGH, the data at SDA will be interpreted as data. When the pin is pulled LOW, the data at SDA will be interpreted as command.

Note 5-3: This pin (RES#) is reset signal input. The Reset is active low.

Note 5-4: This pin is Busy state output pin. When Busy is High, the operation of chip should not be interrupted, command should not be sent. The chip would put Busy pin High when -Outputting display waveform -Communicating with digital temperature sensor

Note 5-5: Bus interface selection pin

BS1 State	MCU Interface
L	4-lines serial peripheral interface(SPI) - 8 bits SPI
H	3- lines serial peripheral interface(SPI) - 9 bits SPI

6. Electrical Characteristics

6.1 Absolute Maximum Rating

Parameter	Symbol	Rating	Unit
Logic supply voltage	VCI	-0.5 to +6.0	V
Logic Input voltage	VIN	-0.5 to VCI +0.5	V
Logic Output voltage	VOUT	-0.5 to VCI +0.5	V
Operating Temp range	TOPR	0 to +50	°C
Storage Temp range	TSTG	-25 to+70	°C
Optimal Storage Temp	TSTGo	23±2	°C
Optimal Storage Humidity	HSTGo	55±10	%RH

Note:

Maximum ratings are those values beyond which damages to the device may occur. Functional operation should be restricted to the limits in the Panel DC Characteristics tables.

6.2 Panel DC Characteristics

The following specifications apply for: VSS=0V, VCI=3.0V, TOPR =25°C.

Parameter	Symbol	Conditions	Applicable pin	Min.	Typ.	Max	Units
Single ground	V _{SS}	--		-	0	-	V
Logic supply voltage	V _{CI}		VCI	2.2	3.0	3.7	V
Core logic voltage	V _{DD}		VDD	1.7	1.8	1.9	V
High level input voltage	V _{IH}	-	--	0.8 V _{CI}	-	-	V
Low level input voltage	V _{IL}	-	--	-	-	0.2 V _{CI}	V
High level output voltage	V _{OH}	IOH = - 100uA	--	0.9 VCI	-	-	V
Low level output voltage	V _{OL}	IOL = 100uA	--	--	-	0.1 V _{CI}	V
Typical power	P _{TYP}	V _{CI} =3.0V	--	--	TBD	--	mW
Deep sleep mode	P _{STPY}	V _{CI} =3.0V		--	0.003	--	mW
Typical operating current	Iopr_V _{CI}	V _{CI} =3.0V		-	TBD	--	mA
Full update time	--	25 °C			3		sec
Fast update time	-	25 °C			1.5		sec
Partial update time		25 °C			0.42		sec
Sleep mode current	Islp_V _{CI}	DC/ DC off No clock No input load Ram data retain	-	-	20		uA
Deep sleep mode current	Idslp_V _{CI}	DC/ DC off No clock No input load Ram data not retain	-	-	1	5	uA

Notes:

1) Refresh time: the time it takes for the whole process from the screen change to the screen stabilization.

2) The difference between different refresh methods:

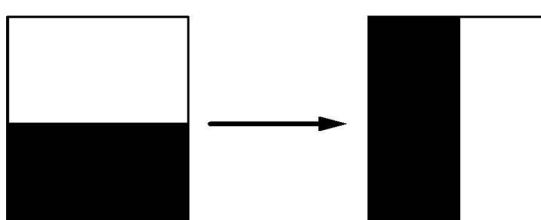
Full refresh: The screen will flicker several times during the refresh process;

Fast Refresh: The screen will flash once during the refresh process;

Partial refresh: The screen does not flicker during the refresh process.

During the fast refresh or partial refresh of the electronic paper, it is recommended to add a full-screen refresh after 5 consecutive operations to reduce the accumulation of afterimages on the screen.

1. The typical power is measured with following transition from horizontal 2 scale pattern to vertical 2 scale pattern.
2. The deep sleep power is the consumed power when the panel controller is in deep sleep mode.
3. The listed electrical/optical characteristics are only guaranteed under the controller & waveform provided by GOOD DISPLAY.



6.3 Panel AC Characteristics

6.3.1 MCU Interface Selection

MCU interface is pin selectable by BS1 shown in Table 6-1.

Table 6-1 : Interface pins assignment under different MCU interface

MCU Interface	Pin Name					
	BS1	RES#	CS#	D/C#	SCL	SDA
4-wire serial peripheral interface (SPI)	L	RES#	CS#	DC#	SCL	SDA
3-wire serial peripheral interface (SPI) – 9 bits SPI	H	RES#	CS#	L	SCL	SDA

Note : (1) L is connected to VSS and H is connected to VDDIO

6.3.2 MCU Serial Interface (4-wire SPI)

The 4-wire SPI consists of serial clock SCL, serial data SDA, D/C# and CS#. The control pins status in 4-wire SPI in writing command/data is shown in Table 6-2 and the write procedure 4-wire SPI is shown in Table 6-2

Table 6-2 : Control pins status of 4-wire SPI

Function	SCL pin	SDA pin	D/C# pin	CS# pin
Write command	↑	Command bit	L	L
Write data	↑	Data bit	H	L

Note: (1) L is connected to VSS and H is connected to VDDIO

(2) ↑ stands for rising edge of signal

(3) SDA (Write Mode) is shifted into an 8-bit shift register on every rising edge of SCL in the order of D7, D6, ... D0. The level of D/C# should be kept over the whole byte. The data byte in the shift register is written to the Graphic Display Data RAM (RAM)/Data Byte register or command Byte register according to D/C# pin.

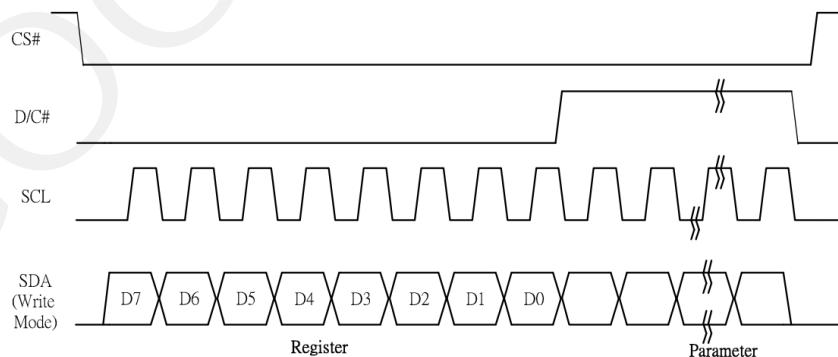


Figure 6-1 : Write procedure in 4-wire SPI mode

In the read operation (Command 0x1B, 0x27, 0x2D, 0x2E, 0x2F, 0x35). After CS # is pulled low, the first byte sent is command byte, D/C# is pulled low. After command byte sent, the following byte(s) read are data byte(s), so D/C# bit is then pulled high. An 8-bit data will be shifted out on every clock falling edge. The serial data SDA bit shifting sequence is D7, D6, to D0 bit. Figure 6-2 shows the read procedure in 4-wire SPI.

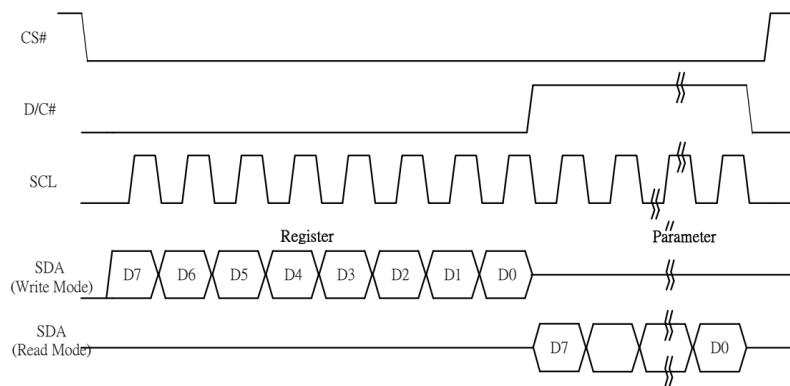


Figure 6-2 : Read procedure in 4-wire SPI mode

6.3.3 MCU Serial Interface (3-wire SPI)

The 3-wire SPI consists of serial clock SCL, serial data SDA and CS#. The operation is similar to 4-wire SPI while D/C# pin is not used and it must be tied to LOW. The control pins status in 3-wire SPI is shown in Table 6-3.

In the write operation, a 9-bit data will be shifted into the shift register on every clock rising edge. The bit shifting sequence is D/C# bit, D7 bit, D6 bit to D0 bit. The first bit is D/C# bit which determines the following byte is command or data. When D/C# bit is 0, the following byte is command. When D/C# bit is 1, the following byte is data. Table 6-3 shows the write procedure in 3-wire SPI

Table 6-3 : Control pins status of 3-wire SPI

Function	SCL pin	SDA pin	D/C# pin	CS# pin
Write command	↑	Command bit	Tie LOW	L
Write data	↑	Data bit	Tie LOW	L

Note: (1) L is connected to VSS and H is connected to VDDIO

(2) ↑ stands for rising edge of signal

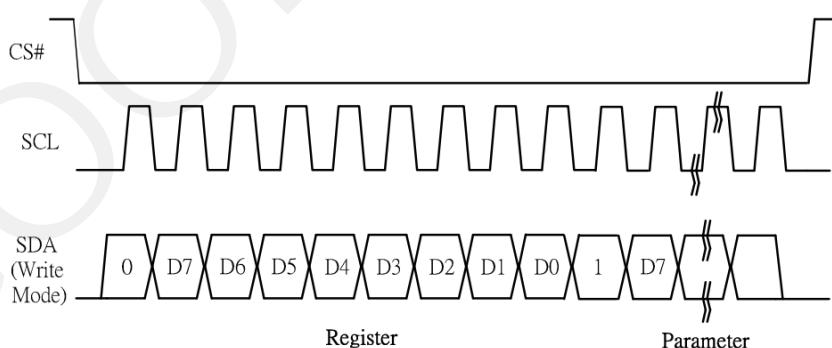


Figure 6-3 : Write procedure in 3-wire SPI

In the read operation (Register 0x1B, 0x27, 0x2D, 0x2E, 0x2F, 0x35). SDA data are transferred in the unit of 9 bits. After CS# pull low, the first byte is command byte, the D/C# bit is as 0 and following with the register byte. After command byte send, the following byte(s) are data byte(s), with D/C# bit is 1. After D/C# bit sending from MCU, an 8-bit data will be shifted out on every clock falling edge. The serial data SDA bit shifting sequence is D7, D6, to D0 bit. Figure 6-4 shows the read procedure in 3-wire SPI.

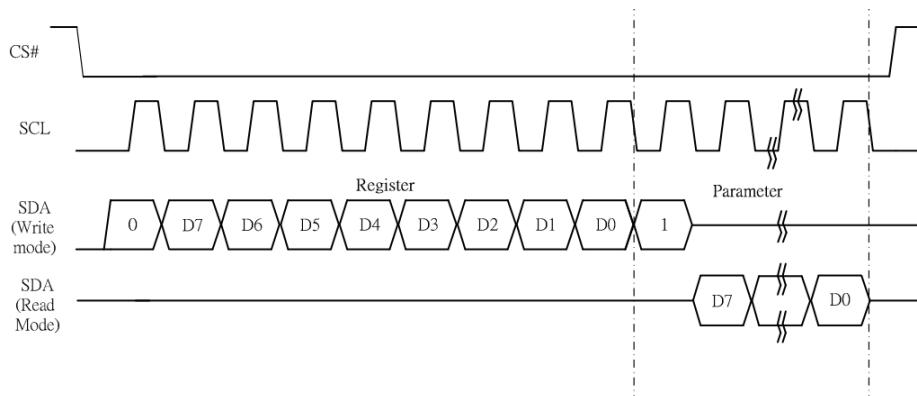


Figure 6-4 : Read procedure in 3-wire SPI mode

6.3.4 Interface Timing

The following specifications apply for: VDDIO - VSS = 2.2V to 3.7V, CL=20pF

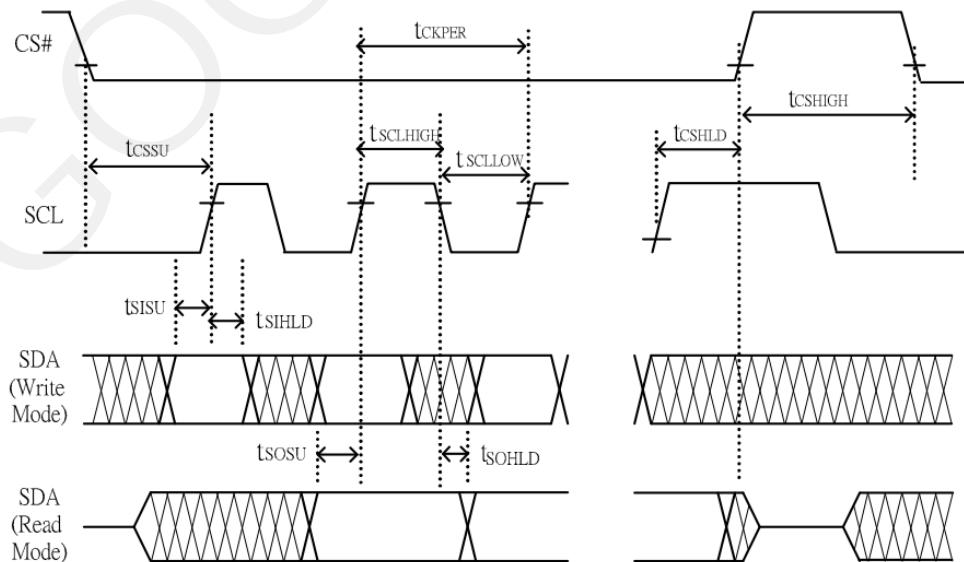
Write mode

Symbol	Parameter	Min	Typ	Max	Unit
f _{SCL}	SCL frequency (Write Mode)	-	-	20	MHz
t _{CSSU}	Time CS# has to be low before the first rising edge of SCLK	60	-	-	ns
t _{CSHLD}	Time CS# has to remain low after the last falling edge of SCLK	65	-	-	ns
t _{CSHIGH}	Time CS# has to remain high between two transfers	100	-	-	ns
t _{SCLHIGH}	Part of the clock period where SCL has to remain high	25	-	-	ns
t _{SCLLOW}	Part of the clock period where SCL has to remain low	25	-	-	ns
t _{SI_{SU}}	Time SI (SDA Write Mode) has to be stable before the next rising edge of SCL	10	-	-	ns
t _{SI_{HLD}}	Time SI (SDA Write Mode) has to remain stable after the rising edge of SCL	40	-	-	ns

Read mode

Symbol	Parameter	Min	Typ	Max	Unit
f _{SCL}	SCL frequency (Read Mode)	-	-	2.5	MHz
t _{CSSU}	Time CS# has to be low before the first rising edge of SCLK	100	-	-	ns
t _{CSHLD}	Time CS# has to remain low after the last falling edge of SCLK	50	-	-	ns
t _{CSHIGH}	Time CS# has to remain high between two transfers	250	-	-	ns
t _{SCLHIGH}	Part of the clock period where SCL has to remain high	180	-	-	ns
t _{SCLLOW}	Part of the clock period where SCL has to remain low	180	-	-	ns
t _{SO_{SU}}	Time SO (SDA Read Mode) will be stable before the next rising edge of SCL	-	50	-	ns
t _{SO_{HLD}}	Time SO (SDA Read Mode) will remain stable after the falling edge of SCL	-	0	-	ns

Note: All timings are based on 20% to 80% of VDDIO-VSS



7. Command Table

Command Table												
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	0	01	0	0	0	0	0	0	0	1	Driver Output control	Gate setting A[8:0]= 127h [POR], 296 MUX MUX Gate lines setting as (A[8:0] + 1).
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		B [2:0] = 000 [POR]. Gate scanning sequence and direction
0	1		0	0	0	0	0	0	0	A ₈		B[2]: GD Selects the 1st output Gate GD=0 [POR], G0 is the 1st gate output channel, gate output sequence is G0,G1, G2, G3, ... GD=1, G1 is the 1st gate output channel, gate output sequence is G1, G0, G3, G2, ...
0	1		0	0	0	0	0	B ₂	B ₁	B ₀		B[1]: SM Change scanning order of gate driver. SM=0 [POR], G0, G1, G2, G3...295 (left and right gate interlaced) SM=1, G0, G2, G4 ...G294, G1, G3, ...G295
												B[0]: TB TB = 0 [POR], scan from G0 to G295 TB = 1, scan from G295 to G0.
0	0	03	0	0	0	0	0	0	1	1	Gate Driving voltage Control	Set Gate driving voltage A[4:0] = 00h [POR] VGH setting from 10V to 20V
0	1		0	0	0	A ₄	A ₃	A ₂	A ₁	A ₀		A[4:0] VGH A[4:0] VGH
												00h 20 0Dh 15
												03h 10 0Eh 15.5
												04h 10.5 0Fh 16
												05h 11 10h 16.5
												06h 11.5 11h 17
												07h 12 12h 17.5
												08h 12.5 13h 18
												07h 12 14h 18.5
												08h 12.5 15h 19
												09h 13 16h 19.5
												0Ah 13.5 17h 20
												0Bh 14 Other NA
												0Ch 14.5

Command Table																																																																																																																																																				
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																																																																																																																																								
0	0	04	0	0	0	0	0	1	0	0	Source Driving voltage Control	Set Source driving voltage A[7:0] = 41h [POR], VSH1 at 15V B [7:0] = A8h [POR], VSH2 at 5V. C[7:0] = 32h [POR], VSL at -15V Remark: VSH1>=VSH2																																																																																																																																								
0	1		A7	A6	A5	A4	A3	A2	A1	A0																																																																																																																																										
0	1		B7	B6	B5	B4	B3	B2	B1	B0																																																																																																																																										
0	1		C7	C6	C5	C4	C3	C2	C1	C0																																																																																																																																										
A[7]/B[7] = 1, VSH1/VSH2 voltage setting from 2.4V to 8.8V												A[7]/B[7] = 0, VSH1/VSH2 voltage setting from 9V to 17V																																																																																																																																								
<table border="1"> <thead> <tr> <th>A/B[7:0]</th><th>VSH1/VSH2</th><th>A/B[7:0]</th><th>VSH1/VSH2</th></tr> </thead> <tbody> <tr><td>8Eh</td><td>2.4</td><td>Afh</td><td>5.7</td></tr> <tr><td>8Fh</td><td>2.5</td><td>B0h</td><td>5.8</td></tr> <tr><td>90h</td><td>2.6</td><td>B1h</td><td>5.9</td></tr> <tr><td>91h</td><td>2.7</td><td>B2h</td><td>6</td></tr> <tr><td>92h</td><td>2.8</td><td>B3h</td><td>6.1</td></tr> <tr><td>93h</td><td>2.9</td><td>B4h</td><td>6.2</td></tr> <tr><td>94h</td><td>3</td><td>B5h</td><td>6.3</td></tr> <tr><td>95h</td><td>3.1</td><td>B6h</td><td>6.4</td></tr> <tr><td>96h</td><td>3.2</td><td>B7h</td><td>6.5</td></tr> <tr><td>97h</td><td>3.3</td><td>B8h</td><td>6.6</td></tr> <tr><td>98h</td><td>3.4</td><td>B9h</td><td>6.7</td></tr> <tr><td>99h</td><td>3.5</td><td>BAh</td><td>6.8</td></tr> <tr><td>9Ah</td><td>3.6</td><td>BBh</td><td>6.9</td></tr> <tr><td>9Bh</td><td>3.7</td><td>BCh</td><td>7</td></tr> <tr><td>9Ch</td><td>3.8</td><td>BDh</td><td>7.1</td></tr> <tr><td>9Dh</td><td>3.9</td><td>BEh</td><td>7.2</td></tr> <tr><td>9Eh</td><td>4</td><td>Bfh</td><td>7.3</td></tr> <tr><td>9Fh</td><td>4.1</td><td>C0h</td><td>7.4</td></tr> <tr><td>A0h</td><td>4.2</td><td>C1h</td><td>7.5</td></tr> <tr><td>A1h</td><td>4.3</td><td>C2h</td><td>7.6</td></tr> <tr><td>A2h</td><td>4.4</td><td>C3h</td><td>7.7</td></tr> <tr><td>A3h</td><td>4.5</td><td>C4h</td><td>7.8</td></tr> <tr><td>A4h</td><td>4.6</td><td>C5h</td><td>7.9</td></tr> <tr><td>A5h</td><td>4.7</td><td>C6h</td><td>8</td></tr> <tr><td>A6h</td><td>4.8</td><td>C7h</td><td>8.1</td></tr> <tr><td>A7h</td><td>4.9</td><td>C8h</td><td>8.2</td></tr> <tr><td>A8h</td><td>5</td><td>C9h</td><td>8.3</td></tr> <tr><td>A9h</td><td>5.1</td><td>CAh</td><td>8.4</td></tr> <tr><td>AAh</td><td>5.2</td><td>CBh</td><td>8.5</td></tr> <tr><td>ABh</td><td>5.3</td><td>CCh</td><td>8.6</td></tr> <tr><td>ACh</td><td>5.4</td><td>CDh</td><td>8.7</td></tr> <tr><td>ADh</td><td>5.5</td><td>CEh</td><td>8.8</td></tr> <tr><td>AEh</td><td>5.6</td><td>Other</td><td>NA</td></tr> </tbody> </table>												A/B[7:0]	VSH1/VSH2	A/B[7:0]	VSH1/VSH2	8Eh	2.4	Afh	5.7	8Fh	2.5	B0h	5.8	90h	2.6	B1h	5.9	91h	2.7	B2h	6	92h	2.8	B3h	6.1	93h	2.9	B4h	6.2	94h	3	B5h	6.3	95h	3.1	B6h	6.4	96h	3.2	B7h	6.5	97h	3.3	B8h	6.6	98h	3.4	B9h	6.7	99h	3.5	BAh	6.8	9Ah	3.6	BBh	6.9	9Bh	3.7	BCh	7	9Ch	3.8	BDh	7.1	9Dh	3.9	BEh	7.2	9Eh	4	Bfh	7.3	9Fh	4.1	C0h	7.4	A0h	4.2	C1h	7.5	A1h	4.3	C2h	7.6	A2h	4.4	C3h	7.7	A3h	4.5	C4h	7.8	A4h	4.6	C5h	7.9	A5h	4.7	C6h	8	A6h	4.8	C7h	8.1	A7h	4.9	C8h	8.2	A8h	5	C9h	8.3	A9h	5.1	CAh	8.4	AAh	5.2	CBh	8.5	ABh	5.3	CCh	8.6	ACh	5.4	CDh	8.7	ADh	5.5	CEh	8.8	AEh	5.6	Other	NA	C[7] = 0, VSL setting from -5V to -17V
A/B[7:0]	VSH1/VSH2	A/B[7:0]	VSH1/VSH2																																																																																																																																																	
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R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																																
0	0	0C	0	0	0	0	1	1	0	0	Booster Soft start Control	Booster Enable with Phase 1, Phase 2 and Phase 3 for soft start current and duration setting.																																
0	1		1	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		A[7:0] -> Soft start setting for Phase1 = 8Bh [POR]																																
0	1		1	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀		B[7:0] -> Soft start setting for Phase2 = 9Ch [POR]																																
0	1		1	C ₆	C ₅	C ₄	C ₃	C ₂	C ₁	C ₀		C[7:0] -> Soft start setting for Phase3 = 96h [POR]																																
0	1		0	0	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀		D[7:0] -> Duration setting = 0Fh [POR]																																
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0	0	10	0	0	0	1	0	0	0	0	Deep Sleep mode	Deep Sleep mode Control:																																
0	1		0	0	0	0	0	0	A ₁	A ₀		<table border="1"> <thead> <tr> <th>A[1:0] :</th><th>Description</th></tr> </thead> <tbody> <tr><td>00</td><td>Normal Mode [POR]</td></tr> <tr><td>01</td><td>Enter Deep Sleep Mode 1</td></tr> <tr><td>11</td><td>Enter Deep Sleep Mode 2</td></tr> </tbody> </table>	A[1:0] :	Description	00	Normal Mode [POR]	01	Enter Deep Sleep Mode 1	11	Enter Deep Sleep Mode 2																								
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11	Enter Deep Sleep Mode 2																																											
												After this command initiated, the chip will enter Deep Sleep Mode, BUSY pad will keep output high. Remark: To Exit Deep Sleep mode, User required to send HWRESET to the driver																																

Command Table												
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	0	11	0	0	0	1	0	0	0	1	Data Entry mode setting	Define data entry sequence A[2:0] = 011 [POR]
0	1		0	0	0	0	0	A ₂	A ₁	A ₀		A [1:0] = ID[1:0] Address automatic increment / decrement setting The setting of incrementing or decrementing of the address counter can be made independently in each upper and lower bit of the address. 00 –Y decrement, X decrement, 01 –Y decrement, X increment, 10 –Y increment, X decrement, 11 –Y increment, X increment [POR]
0	0	12	0	0	0	1	0	0	1	0	SW RESET	A[2] = AM Set the direction in which the address counter is updated automatically after data are written to the RAM. AM= 0, the address counter is updated in the X direction. [POR] AM = 1, the address counter is updated in the Y direction.
0	0	14	0	0	0	1	0	1	0	0	HV Ready Detection	HV ready detection A[7:0] = 00h [POR] The command required CLKEN=1 and ANALOGEN=1. Refer to Register 0x22 for detail. After this command initiated, HV Ready detection starts. BUSY pad will output high during detection. The detection result can be read from the Status Bit Read (Command 0x2F).
0	1		0	A ₆	A ₅	A ₄	0	A ₂	A ₁	A ₀		A[6:4]=n for cool down duration: 10ms x (n+1) A[2:0]=m for number of Cool Down Loop to detect. The max HV ready duration is 10ms x (n+1) x (m) HV ready detection will be trigger after each cool down time. The detection will be completed when HV is ready. For 1 shot HV ready detection, A[7:0] can be set as 00h.

Command Table													Description														
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command																
0	0	15	0	0	0	1	0	1	0	1	VCI Detection	VCI Detection A[2:0] = 100 [POR], Detect level at 2.3V A[2:0] : VCI level Detect	<table border="1"> <tr><td>A[2:0]</td><td>VCI level</td></tr> <tr><td>011</td><td>2.2V</td></tr> <tr><td>100</td><td>2.3V</td></tr> <tr><td>101</td><td>2.4V</td></tr> <tr><td>110</td><td>2.5V</td></tr> <tr><td>111</td><td>2.6V</td></tr> <tr><td>Other</td><td>NA</td></tr> </table>	A[2:0]	VCI level	011	2.2V	100	2.3V	101	2.4V	110	2.5V	111	2.6V	Other	NA
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Other	NA																										
0	1		0	0	0	0	0	A ₂	A ₁	A ₀		The command required CLKEN=1 and ANALOGEN=1 Refer to Register 0x22 for detail. After this command initiated, VCI detection starts. BUSY pad will output high during detection. The detection result can be read from the Status Bit Read (Command 0x2F).															
0	0	18	0	0	0	1	1	0	0	0	Temperature Sensor Control	Temperature Sensor Selection A[7:0] = 48h [POR], external temperatrure sensor A[7:0] = 80h Internal temperature sensor															
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀																	
0	0	1A	0	0	0	1	1	0	1	0	Temperature Sensor Control (Write to temperature register)	Write to temperature register. A[7:0] = 7Fh [POR]															
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀																	
0	0	1B	0	0	0	1	1	0	1	1	Temperature Sensor Control (Read from temperature register)	Read from temperature register.															
1	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀																	
0	0	1C	0	0	0	1	1	1	0	0	Temperature Sensor Control (Write Command to External temperature sensor)	Write Command to External temperature sensor. A[7:0] = 00h [POR], B[7:0] = 00h [POR], C[7:0] = 00h [POR],															
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀																	
0	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀																	
0	1		C ₇	C ₆	C ₅	C ₄	C ₃	C ₂	C ₁	C ₀																	
												A[7:6]	<table border="1"> <tr><td>A[7:6]</td><td>Select no of byte to be sent</td></tr> <tr><td>00</td><td>Address + pointer</td></tr> <tr><td>01</td><td>Address + pointer + 1st parameter</td></tr> <tr><td>10</td><td>Address + pointer + 1st parameter + 2nd pointer</td></tr> <tr><td>11</td><td>Address</td></tr> </table>	A[7:6]	Select no of byte to be sent	00	Address + pointer	01	Address + pointer + 1st parameter	10	Address + pointer + 1st parameter + 2nd pointer	11	Address				
A[7:6]	Select no of byte to be sent																										
00	Address + pointer																										
01	Address + pointer + 1st parameter																										
10	Address + pointer + 1st parameter + 2nd pointer																										
11	Address																										
												A[5:0] – Pointer Setting B[7:0] – 1 st parameter C[7:0] – 2 nd parameter The command required CLKEN=1. Refer to Register 0x22 for detail.															
0	0	1F	0	0	0	1	1	1	1	1	IC revision Read	Read IC revision [POR 0x0D]															
1	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀																	

Command Table												
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	0	20	0	0	1	0	0	0	0	0	Master Activation	Activate Display Update Sequence The Display Update Sequence Option is located at R22h. BUSY pad will output high during operation. User should not interrupt this operation to avoid corruption of panel images.
0	0	21	0	0	1	0	0	0	0	1	Display Update Control 1	RAM content option for Display Update A[7:0] = 00h [POR] B[7:0] = 00h [POR]
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		A[7:4] Red RAM option 0000 Normal 0100 Bypass RAM content as 0 1000 Inverse RAM content
0	1		B ₇	0	0	0	0	0	0	0		A[3:0] BW RAM option 0000 Normal 0100 Bypass RAM content as 0 1000 Inverse RAM content
0	1											B[7] Source Output Mode 0 Available Source from S0 to S175 1 Available Source from S8 to S167
0	0	24	0	0	1	0	0	1	0	0		Write RAM (Black White) / RAM 0x24 After this command, data entries will be written into the BW RAM until another command is written. Address pointers will advance accordingly For Write pixel: Content of Write RAM(BW) = 1 For Black pixel: Content of Write RAM(BW) = 0

Command Table												
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	0	22	0	0	1	0	0	0	1	0	Display Update Control 2	Display Update Sequence Option: Enable the stage for Master Activation A[7:0]= FFh (POR)
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		Operating sequence Parameter (In Hex)
												Enable clock signal 80
												Disable clock signal 01
												Enable clock signal → Enable Analog C0
												Disable Analog → Disable clock signal 03
												Enable clock signal → Load LUT with DISPLAY Mode 1 → Disable clock signal 91
												Enable clock signal → Load LUT with DISPLAY Mode 2 → Disable clock signal 99
												Enable clock signal → Load temperature value → Load LUT with DISPLAY Mode 1 → Disable clock signal B1
												Enable clock signal → Load temperature value → Load LUT with DISPLAY Mode 2 → Disable clock signal B9
												Enable clock signal → Enable Analog → Display with DISPLAY Mode 1 → Disable Analog → Disable OSC C7
												Enable clock signal → Enable Analog → Display with DISPLAY Mode 2 → Disable Analog → Disable OSC CF
												Enable clock signal → Enable Analog → Load temperature value → DISPLAY with DISPLAY Mode 1 → Disable Analog → Disable OSC F7
												Enable clock signal → Enable Analog → Load temperature value → DISPLAY with DISPLAY Mode 2 → Disable Analog → Disable OSC FF
0	0	26	0	0	1	0	0	1	1	0	Write RAM (RED) / RAM 0x26	After this command, data entries will be written into the RED RAM until another command is written. Address pointers will advance accordingly. For Red pixel: Content of Write RAM(RED) = 1 For non-Red pixel [Black or White]: Content of Write RAM(RED) = 0
0	0	27	0	0	1	0	0	1	1	1	Read RAM	After this command, data read on the MCU bus will fetch data from RAM. According to parameter of Register 41h to select reading RAM0x24/ RAM0x26, until another command is written. Address pointers will advance accordingly. The 1 st byte of data read is dummy data.

Command Table																																																																												
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																																																																
0	0	28	0	0	1	0	1	0	0	0	VCOM Sense	Enter VCOM sensing conditions and hold for duration defined in 29h before reading VCOM value. The sensed VCOM voltage is stored in register The command required CLKEN=1 and ANALOGEN=1 Refer to Register 0x22 for detail. BUSY pad will output high during operation.																																																																
0	0	29	0	0	1	0	1	0	0	1	VCOM Sense Duration	Stabling time between entering VCOM sensing mode and reading acquired. A[3:0] = 9h, duration = 10s. VCOM sense duration = (A[3:0]+1) sec																																																																
0	0	2A	0	0	1	0	1	0	1	0	Program VCOM OTP	Program VCOM register into OTP The command required CLKEN=1. Refer to Register 0x22 for detail. BUSY pad will output high during operation.																																																																
0	0	2C	0	0	1	0	1	1	0	0	Write VCOM register	Write VCOM register from MCU interface A[7:0] = 00h [POR]																																																																
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		<table border="1"> <thead> <tr> <th>A[7:0]</th> <th>VCOM</th> <th>A[7:0]</th> <th>VCOM</th> </tr> </thead> <tbody> <tr> <td>08h</td> <td>-0.2</td> <td>44h</td> <td>-1.7</td> </tr> <tr> <td>0Ch</td> <td>-0.3</td> <td>48h</td> <td>-1.8</td> </tr> <tr> <td>10h</td> <td>-0.4</td> <td>4Ch</td> <td>-1.9</td> </tr> <tr> <td>14h</td> <td>-0.5</td> <td>50h</td> <td>-2</td> </tr> <tr> <td>18h</td> <td>-0.6</td> <td>54h</td> <td>-2.1</td> </tr> <tr> <td>1Ch</td> <td>-0.7</td> <td>58h</td> <td>-2.2</td> </tr> <tr> <td>20h</td> <td>-0.8</td> <td>5Ch</td> <td>-2.3</td> </tr> <tr> <td>24h</td> <td>-0.9</td> <td>60h</td> <td>-2.4</td> </tr> <tr> <td>28h</td> <td>-1</td> <td>64h</td> <td>-2.5</td> </tr> <tr> <td>2Ch</td> <td>-1.1</td> <td>68h</td> <td>-2.6</td> </tr> <tr> <td>30h</td> <td>-1.2</td> <td>6Ch</td> <td>-2.7</td> </tr> <tr> <td>34h</td> <td>-1.3</td> <td>70h</td> <td>-2.8</td> </tr> <tr> <td>38h</td> <td>-1.4</td> <td>74h</td> <td>-2.9</td> </tr> <tr> <td>3Ch</td> <td>-1.5</td> <td>78h</td> <td>-3</td> </tr> <tr> <td>40h</td> <td>-1.6</td> <td>Other</td> <td>NA</td> </tr> </tbody> </table>	A[7:0]	VCOM	A[7:0]	VCOM	08h	-0.2	44h	-1.7	0Ch	-0.3	48h	-1.8	10h	-0.4	4Ch	-1.9	14h	-0.5	50h	-2	18h	-0.6	54h	-2.1	1Ch	-0.7	58h	-2.2	20h	-0.8	5Ch	-2.3	24h	-0.9	60h	-2.4	28h	-1	64h	-2.5	2Ch	-1.1	68h	-2.6	30h	-1.2	6Ch	-2.7	34h	-1.3	70h	-2.8	38h	-1.4	74h	-2.9	3Ch	-1.5	78h	-3	40h	-1.6	Other	NA
A[7:0]	VCOM	A[7:0]	VCOM																																																																									
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Command Table												
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	0	2D	0	0	1	0	1	1	0	1	OTP Register Read for Display Option	Read Register for Display Option:
1	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		A[7:0]: VCOM OTP Selection (Command 0x37, Byte A)
1	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀		B[7:0]: VCOM Register (Command 0x2C)
1	1		C ₇	C ₆	C ₅	C ₄	C ₃	C ₂	C ₁	C ₀		C[7:0]~G[7:0]: Display Mode (Command 0x37, Byte B to Byte F) [5 bytes]
1	1		D ₇	D ₆	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀		H[7:0]~K[7:0]: Waveform Version (Command 0x37, Byte G to Byte J) [4 bytes]
1	1		E ₇	E ₆	E ₅	E ₄	E ₃	E ₂	E ₁	E ₀		
1	1		F ₇	F ₆	F ₅	F ₄	F ₃	F ₂	F ₁	F ₀		
1	1		G ₇	G ₆	G ₅	G ₄	G ₃	G ₂	G ₁	G ₀		
1	1		H ₇	H ₆	H ₅	H ₄	H ₃	H ₂	H ₁	H ₀		
1	1		I ₇	I ₆	I ₅	I ₄	I ₃	I ₂	I ₁	I ₀		
1	1		J ₇	J ₆	J ₅	J ₄	J ₃	J ₂	J ₁	J ₀		
1	1		K ₇	K ₆	K ₅	K ₄	K ₃	K ₂	K ₁	K ₀		
0	0	2E	0	0	1	0	1	1	1	0	User ID Read	Read 10 Byte User ID stored in OTP: A[7:0]~J[7:0]: UserID (R38, Byte A and Byte J) [10 bytes]
1	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		
1	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀		
1	1		C ₇	C ₆	C ₅	C ₄	C ₃	C ₂	C ₁	C ₀		
1	1		D ₇	D ₆	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀		
1	1		E ₇	E ₆	E ₅	E ₄	E ₃	E ₂	E ₁	E ₀		
1	1		F ₇	F ₆	F ₅	F ₄	F ₃	F ₂	F ₁	F ₀		
1	1		G ₇	G ₆	G ₅	G ₄	G ₃	G ₂	G ₁	G ₀		
1	1		H ₇	H ₆	H ₅	H ₄	H ₃	H ₂	H ₁	H ₀		
1	1		I ₇	I ₆	I ₅	I ₄	I ₃	I ₂	I ₁	I ₀		
1	1		J ₇	J ₆	J ₅	J ₄	J ₃	J ₂	J ₁	J ₀		
0	0	2F	0	0	1	0	1	1	1	1	Status Bit Read	Read IC status Bit [POR 0x01] A[5]: HV Ready Detection flag [POR=0] 0: Ready 1: Not Ready A[4]: VCI Detection flag [POR=0] 0: Normal 1: VCI lower than the Detect level A[3]: [POR=0] A[2]: Busy flag [POR=0] 0: Normal 1: BUSY A[1:0]: Chip ID [POR=01]
1	1		0	0	A ₅	A ₄	0	0	A ₁	A ₀		Remark: A[5] and A[4] status are not valid after RESET, they need to be initiated by command 0x14 and command 0x15 respectively.
0	0	30	0	0	1	1	0	0	0	0		Program WS OTP
												Program OTP of Waveform Setting The contents should be written into RAM before sending this command.
												The command required CLKEN=1. Refer to Register 0x22 for detail. BUSY pad will output high during operation.

Command Table													Description
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command		
0	0	31	0	0	1	1	0	0	0	1	Load WS OTP	Load OTP of Waveform Setting The command required CLKEN=1. Refer to Register 0x22 for detail. BUSY pad will output high during operation.	
0	0	32	0	0	1	1	0	0	1	0	Write LUT register	Write LUT register from MCU interface [227 bytes], which contains the content of VS[nX-LUTm], TP[nX], RP[n], SR[nXY], FR and XON[nXY] Refer to Session 6.7 WAVEFORM SETTING	
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀			
0	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀			
0	1		:	:	:	:	:	:	:	:			
0	1				
0	0	34	0	0	1	1	0	1	0	0	CRC calculation	CRC calculation command For details, please refer to SSD1680A application note. BUSY pad will output high during operation.	
0	0	35	0	0	1	1	0	1	0	1	CRC Status Read	CRC Status Read A[15:0] is the CRC read out value	
1	1		A ₁₅	A ₁₄	A ₁₃	A ₁₂	A ₁₁	A ₁₀	A ₉	A ₈			
1	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀			
0	0	36	0	0	1	1	0	1	1	0	Program OTP selection	Program OTP Selection according to the OTP Selection Control [R37h and R38h] The command required CLKEN=1. Refer to Register 0x22 for detail. BUSY pad will output high during operation.	
0	0	37	0	0	1	1	0	1	1	1	Write Register for Display Option	Write Register for Display Option A[7] Spare VCOM OTP selection 0: Default [POR] 1: Spare B[7:0] Display Mode for WS[7:0] C[7:0] Display Mode for WS[15:8] D[7:0] Display Mode for WS[23:16] 0: Display Mode 1 1: Display Mode 2 F[6]: Ping-Pong for Display Mode 2 0: RAM Ping-Pong disable [POR] 1: RAM Ping-Pong enable G[7:0]~J[7:0] module ID /waveform version. Remarks: 1) A[7:0]~J[7:0] can be stored in OTP 2) RAM Ping-Pong function is not support for Display Mode 1	
0	1		A ₇	0	0	0	0	0	0	0			
0	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀			
0	1		C ₇	C ₆	C ₅	C ₄	C ₃	C ₂	C ₁	C ₀			
0	1		D ₇	D ₆	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀			
0	1		E ₇	E ₆	E ₅	E ₄	E ₃	E ₂	E ₁	E ₀			
0	1		0	F ₆	0	0	F ₃	F ₂	F ₁	F ₀			
0	1		G ₇	G ₆	G ₅	G ₄	G ₃	G ₂	G ₁	G ₀			
0	1		H ₇	H ₆	H ₅	H ₄	H ₃	H ₂	H ₁	H ₀			
0	1		I ₇	I ₆	I ₅	I ₄	I ₃	I ₂	I ₁	I ₀			
0	1		J ₇	J ₆	J ₅	J ₄	J ₃	J ₂	J ₁	J ₀			

Command Table

R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	0	38	0	0	1	1	1	0	0	0	Write Register for User ID A[7:0]~J[7:0]: UserID [10 bytes] Remarks: A[7:0]~J[7:0] can be stored in OTP	
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		
0	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀		
0	1		C ₇	C ₆	C ₅	C ₄	C ₃	C ₂	C ₁	C ₀		
0	1		D ₇	D ₆	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀		
0	1		E ₇	E ₆	E ₅	E ₄	E ₃	E ₂	E ₁	E ₀		
0	1		F ₇	F ₆	F ₅	F ₄	F ₃	F ₂	F ₁	F ₀		
0	1		G ₇	G ₆	G ₅	G ₄	G ₃	G ₂	G ₁	G ₀		
0	1		H ₇	H ₆	H ₅	H ₄	H ₃	H ₂	H ₁	H ₀		
0	1		I ₇	I ₆	I ₅	I ₄	I ₃	I ₂	I ₁	I ₀		
0	1		J ₇	J ₆	J ₅	J ₄	J ₃	J ₂	J ₁	J ₀		
0	0	39	0	0	1	1	1	0	0	1	OTP program mode A[1:0] = 00: Normal Mode [POR] A[1:0] = 11: Internal generated OTP programming voltage : User is required to EXACTLY follow the reference code sequences	
0	1		0	0	0	0	0	0	A ₁	A ₀		
0	0	3C	0	0	1	1	1	1	0	0	Border Waveform Control A[7:6] :Select VBD option A[7:6] Select VBD as 00 GS Transition, Defined in A[2] and A[1:0] 01 Fix Level, Defined in A[5:4] 10 VCOM 11[POR] HiZ A [5:4] Fix Level Setting for VBD A[5:4] VBD level 00 VSS 01 VSH1 10 VSL 11 VSH2 A [1:0] GS Transition setting for VBD VBD Level Selection: 00b: VCOM ; 01b: VSH1; 10b: VSL; 11b: VSH2 A[1:0] VBD Transition 00 LUT0 01 LUT1 10 LUT2 11 LUT3	
0	1		A ₇	A ₆	A ₅	A ₄	0	0	A ₁	A ₀		
0	0	3F	0	0	1	1	1	1	1	1	End Option (EOPT) Data bytes should be set for this command or programmed into Waveform setting. 22h Normal. 07h Source output level keep previous output before power off	
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		

Command Table

R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																				
0	0	41	0	1	0	0	0	0	0	1	Read RAM Option	Read RAM Option A[0]= 0 [POR] 0 : Read RAM corresponding to RAM0x24 1 : Read RAM corresponding to RAM0x26																				
0	1		0	0	0	0	0	0	0	A ₀																						
0	0	44	0	1	0	0	0	1	0	0	Set RAM X - address Start / End position	Specify the start/end positions of the window address in the X direction by an address unit for RAM A[5:0]: XSA[5:0], XStart, POR = 00h B[5:0]: XEA[5:0], XEnd, POR = 15h																				
0	1		0	0	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀																						
0	1		0	0	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀																						
0	0	45	0	1	0	0	0	1	0	1	Set Ram Y- address Start / End position	Specify the start/end positions of the window address in the Y direction by an address unit for RAM A[8:0]: YSA[8:0], YStart, POR = 000h B[8:0]: YEA[8:0], YEnd, POR = 127h																				
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀																						
0	1		0	0	0	0	0	0	0	A ₈																						
0	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀																						
0	1		0	0	0	0	0	0	0	B ₈																						
0	0	46	0	1	0	0	0	1		0	Auto Write RED RAM for Regular Pattern	Auto Write RED RAM for Regular Pattern A[7:0] = 00h [POR]																				
0	1		A ₇	A ₆	A ₅	A ₄	0	A ₂	A ₁	A ₀																						
												A[7]: The 1st step value, POR = 0 A[6:4]: Step Height, POR= 000 Step of alter RAM in Y-direction according to Gate																				
												<table border="1"> <tr> <th>A[6:4]</th><th>Height</th><th>A[6:4]</th><th>Height</th></tr> <tr> <td>000</td><td>8</td><td>100</td><td>128</td></tr> <tr> <td>001</td><td>16</td><td>101</td><td>256</td></tr> <tr> <td>010</td><td>32</td><td>110</td><td>296</td></tr> <tr> <td>011</td><td>64</td><td>111</td><td>NA</td></tr> </table>	A[6:4]	Height	A[6:4]	Height	000	8	100	128	001	16	101	256	010	32	110	296	011	64	111	NA
A[6:4]	Height	A[6:4]	Height																													
000	8	100	128																													
001	16	101	256																													
010	32	110	296																													
011	64	111	NA																													
												A[2:0]: Step Width, POR= 000 Step of alter RAM in X-direction according to Source																				
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A[2:0]	Width	A[2:0]	Width																													
000	8	100	128																													
001	16	101	176																													
010	32	110	NA																													
011	64	111	NA																													
												BUSY pad will output high during operation.																				

Command Table

R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																				
0	0	47	0	1	0	0	0	1	1	1	Auto Write B/W RAM for Regular Pattern	Auto Write B/W RAM for Regular Pattern A[7:0] = 00h [POR]																				
0	1		A ₇	A ₆	A ₅	A ₄	0	A ₂	A ₁	A ₀		A[7]: The 1st step value, POR = 0 A[6:4]: Step Height, POR= 000 Step of alter RAM in Y-direction according to Gate																				
												<table border="1"> <tr> <th>A[6:4]</th><th>Height</th><th>A[6:4]</th><th>Height</th></tr> <tr> <td>000</td><td>8</td><td>100</td><td>128</td></tr> <tr> <td>001</td><td>16</td><td>101</td><td>256</td></tr> <tr> <td>010</td><td>32</td><td>110</td><td>296</td></tr> <tr> <td>011</td><td>64</td><td>111</td><td>NA</td></tr> </table>	A[6:4]	Height	A[6:4]	Height	000	8	100	128	001	16	101	256	010	32	110	296	011	64	111	NA
A[6:4]	Height	A[6:4]	Height																													
000	8	100	128																													
001	16	101	256																													
010	32	110	296																													
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A[2:0]	Width	A[2:0]	Width																													
000	8	100	128																													
001	16	101	176																													
010	32	110	NA																													
011	64	111	NA																													
												During operation, BUSY pad will output high.																				
0	0	4E	0	1	0	0	1	1	1	0	Set RAM X address counter	Make initial settings for the RAM X address in the address counter (AC) A[5:0]: 00h [POR].																				
0	1		0	0	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀																						
0	0	4F	0	1	0	0	1	1	1	1	Set RAM Y address counter	Make initial settings for the RAM Y address in the address counter (AC) A[8:0]: 000h [POR].																				
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀																						
0	1		0	0	0	0	0	0	0	A ₈																						
0	0	7F	0	1	1	1	1	1	1	1	NOP	This command is an empty command; it does not have any effect on the display module. However it can be used to terminate Frame Memory Write or Read Commands.																				

8.Optical Specifications

Measurements are made with that the illumination is under an angle of 45 degree, the detection is perpendicular unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ.	Max	Units	Notes
R	White Reflectivity	White	30	35	-	%	8-1
CR	Contrast Ratio	Indoor	8:1		-		8-2
GN	2Grey Level	-		DS+(WS-DS)*n(m-1)			8-3
T update	Image update time	at 25 °C		3	-	sec	
Life		Topr		1000000times or 5years			

Notes:

8-1. Luminance meter: Eye-One Pro Spectrophotometer.

8-2. CR=Surface Reflectance with all white pixel/Surface Reflectance with all black pixels.

8-3 WS: White state, DS: Dark state

9. Handling, Safety and Environment Requirements

Warning

The display glass may break when it is dropped or bumped on a hard surface. Handle with care. Should the display break, do not touch the electrophoretic material. In case of contact with electrophoretic material, wash with water and soap.

Caution

The display module should not be exposed to harmful gases, such as acid and alkali gases, which corrode electronic components. Disassembling the display module.

Disassembling the display module can cause permanent damage and invalidates the warranty agreements.

Observe general precautions that are common to handling delicate electronic components. The glass can break and front surfaces can easily be damaged. Moreover the display is sensitive to static electricity and other rough environmental conditions.

Data sheet status

Product specification	This data sheet contains final product specifications.
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Limiting values

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

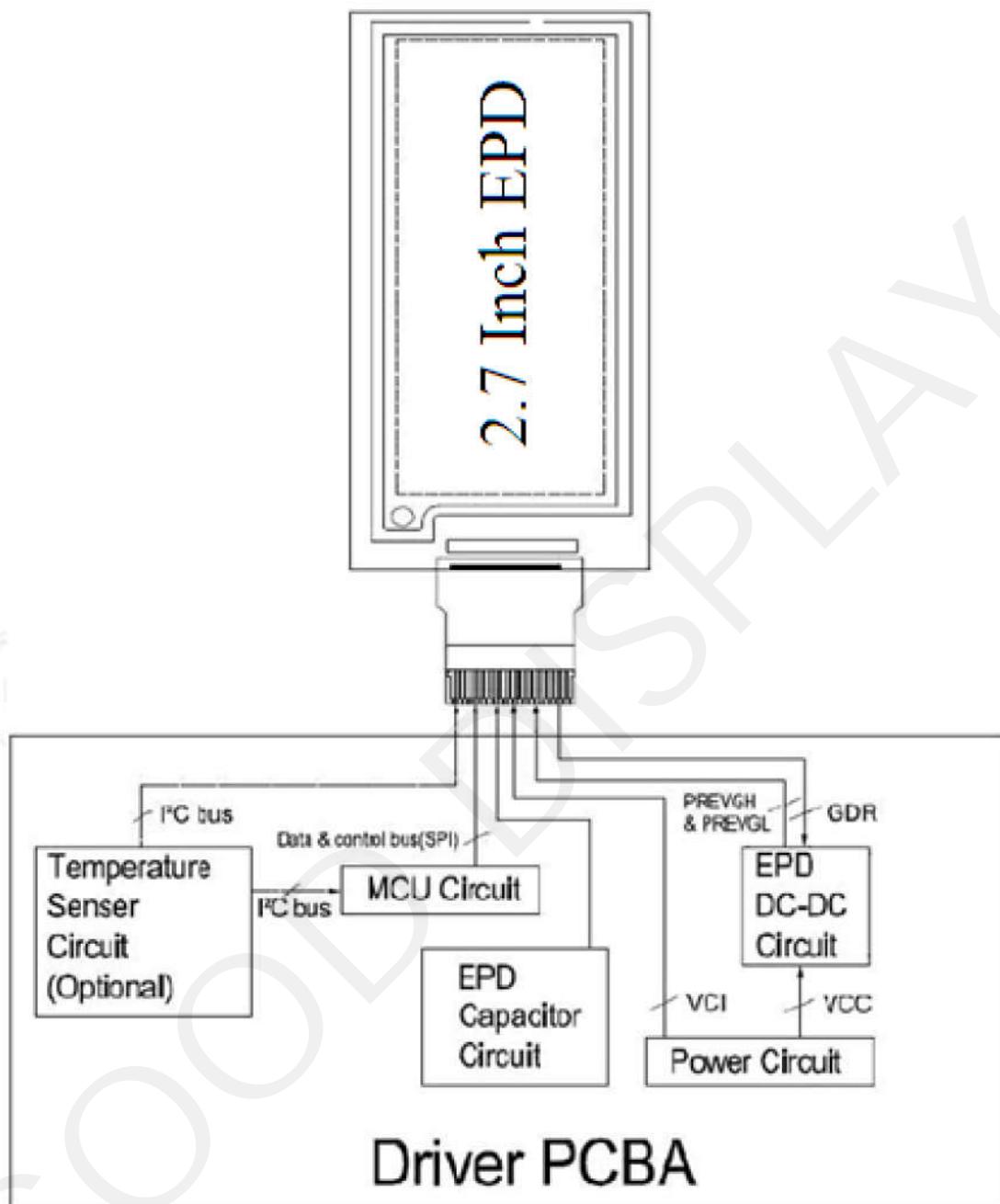
10. Reliability test

NO	Test items	Test condition
1	Low-Temperature Storage	T = -25°C, 240 h Test in white pattern
2	High-Temperature Storage	T=70° C, RH=40%, 240h Test in white pattern
3	High-Temperature Operation	T=50° C, RH=35%, 240h
4	Low-Temperature Operation	0° C, 240h
5	High-Temperature, High-Humidity Operation	T=40° C, RH=80%, 240h
6	High Temperature, High Humidity Storage	T=50° C, RH=80%, 240h Test in white pattern
7	Temperature Cycle	1 cycle:[-25° C 30min]→[+70 ° C 30 min] : 50 cycles Test in white pattern
8	UV exposure Resistance	765W/m ² for 168hrs, 40 °C Test in white pattern
9	ESD Gun	Air+/-15KV; Contact+/-8KV (Test finished product shell, not display only) Air+/-8KV; Contact+/-6KV (Naked EPD display, no including IC and FPC area) Air+/-4KV; Contact+/-2KV (Naked EPD display, including IC and FPC area)

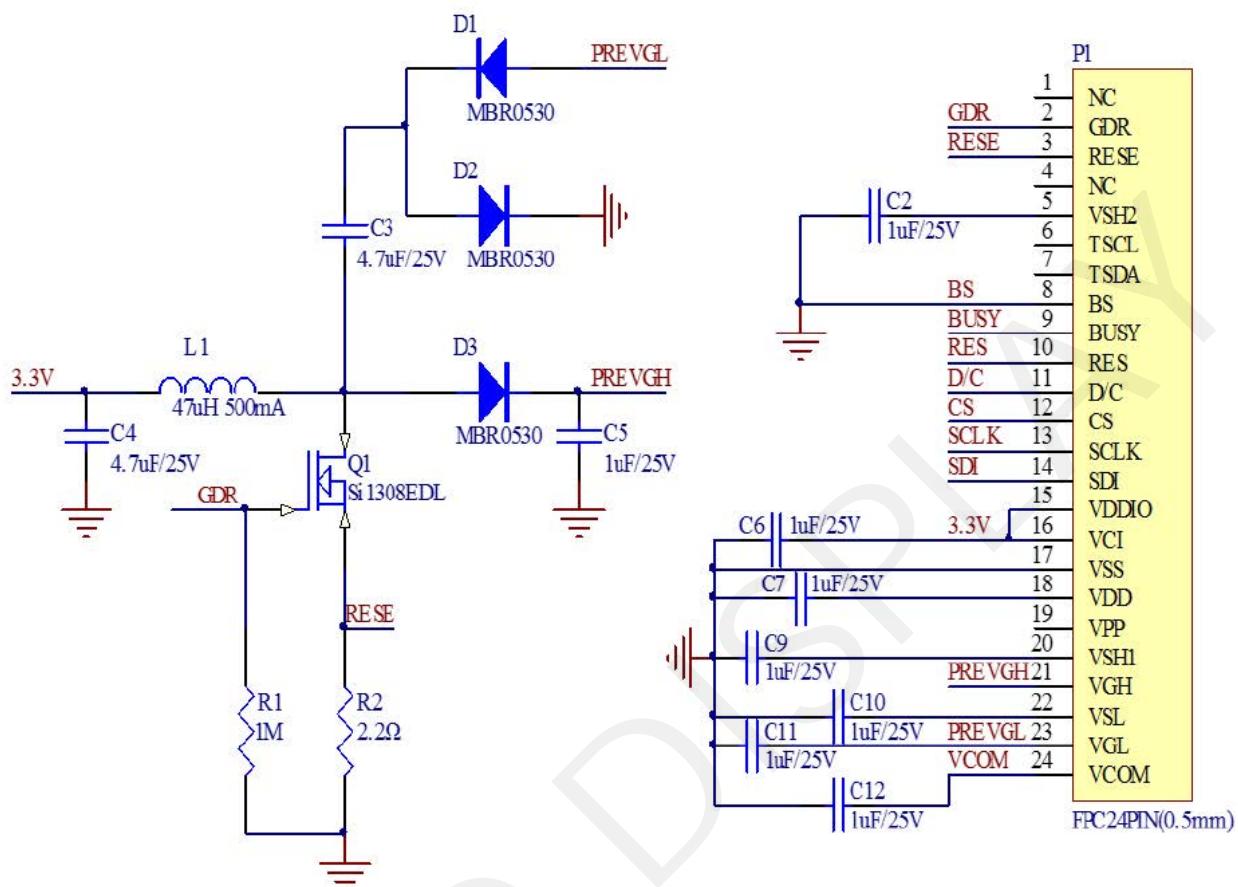
Note:

Put in normal temperature for 1hour after test finished, display performance is ok.

11. Block Diagram



12. Reference Circuit



13. Matched Development Kit

Our Development Kit designed for SPI E-paper Display aims to help users to learn how to use E-paper Display more easily. It can refresh black-white E-paper Display and three-color (black, white and red/Yellow) Good Display's E-paper Display. And it is also added the functions of USB serial port, Raspberry Pi and LED indicator light ect.

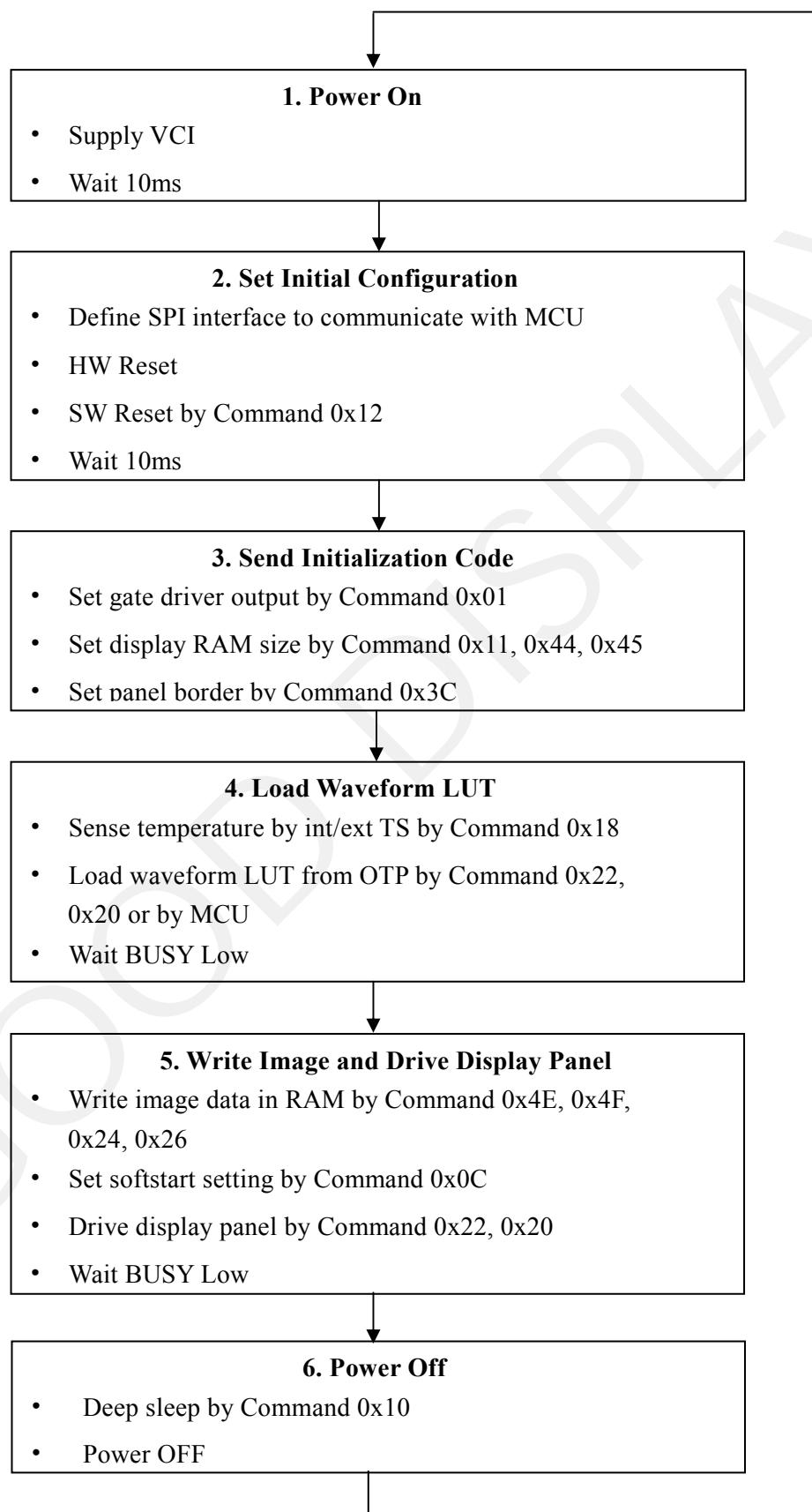
DESPI Development Kit consists of the development board and the pinboard.

More details about the Development Kit, please click to the following link:

<https://www.good-display.com/product/53/>

14.Typical Operating Sequence

14.1 Normal Operation Flow



15. Inspection condition

15.1 Environment

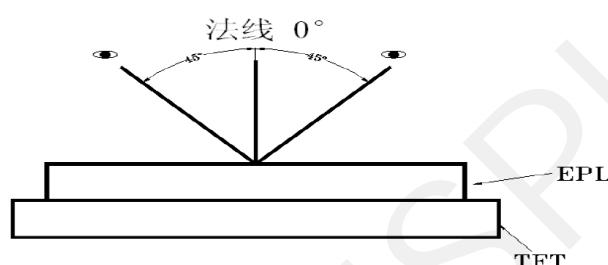
Temperature: $25 \pm 3^\circ\text{C}$

Humidity: $55 \pm 10\%\text{RH}$

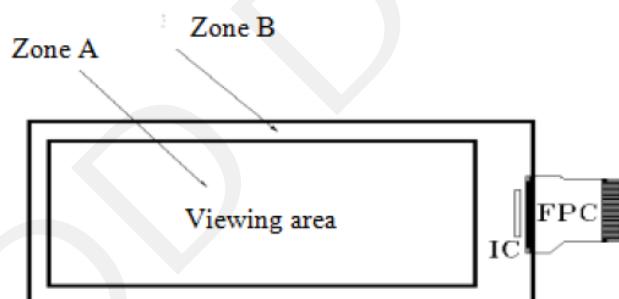
15.2 Illuminance

Brightness: 1200~1500LUX; distance: 20-30CM; Angle: Relate 30° surround.

15.3 Inspection method

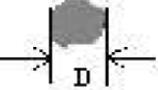


15.4 Display area

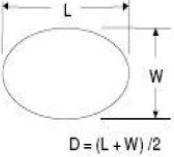
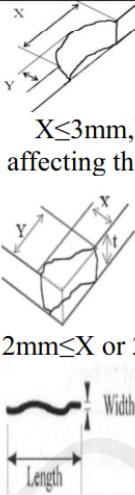


15.5 Inspection standard

15.5.1 Electric inspection standard

NO.	Item	Standard	Defect level	Method	Scope
1	Display	Display complete Display uniform	MA		
2	Black/White spots	 D≤0.25mm, Allowed 0.25mm < D ≤ 0.4mm, N≤3, and Distance≥5mm 0.4mm < D Not Allow	MI	Visual inspection	
3	Black/White spots (No switch)	 L≤0.6mm, W≤0.2mm, N≤1 L≤2.0mm, W>0.2mm, Not Allow L>0.6mm, Not Allow	MI	Visual/ Inspection card	Zone A
4	Ghost image	Allowed in switching process	MI	Visual inspection	
5	Flash spots/ Larger FPL size	Flash spots in switching, Allowed FPL size larger than viewing area, Allowed	MI	Visual/ Inspection card	Zone A Zone B
6	Display wrong/Missing	All appointed displays are showed correct	MA	Visual inspection	Zone A
7	Short circuit/ Circuit break/ Display abnormal	Not Allow			

15.5.2 Appearance inspection standard

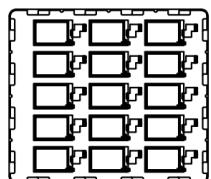
NO.	Item	Standard	Defect level	Method	Scope
1	B/W spots /Bubble/ Foreign bodies/ Dents	 <p>D≤0.25mm, Allowed 0.25mm<D≤0.4mm, N≤3 D>0.4mm, Not Allow</p>	MI	Visual inspection	Zone A
2	Glass crack	Not Allow	MA	Visual / Microscope	Zone A
3	Dirty	Allowed if can be removed			Zone B
4	Chips/Scratch/ Edge crown	 <p>X≤3mm, Y≤0.5mm And without affecting the electrode is permissible 2mm≤X or 2mm≤Y Not Allow W≤0.1mm, L≤5mm, No harm to the electrodes and N≤2 allow</p>	MI	Visual / Microscope	Zone A Zone B
5	TFT Cracks	 <p>Not Allow</p>	MA	Visual / Microscope	Zone A Zone B
6	Dirty/ foreign body	Allowed if can be removed/ allow	MI	Visual / Microscope	Zone A / Zone B
7	FPC broken/ Goldfingers oxidation/ scratch	 <p>Not Allow</p>	MA	Visual / Microscope	Zone B

8	TFT edge bulge /TFT chromatic aberration	TFT edge bulge: X≤3mm, Y≤0.3mm Allowed TFT chromatic aberration :Allowed	MI	Visual / Microscope	Zone A Zone B
9	PCB damaged/ Poor welding/ Curl	PCB (Circuit area) damaged Not Allow PCB Poor welding Not Allow PCB Curl≤1%			
10	Edge glue height/ Edge glue bubble	Edge Adhesives H≤PS surface (Including protect film) Edge adhesives seep in≤1/2 Margin width Length excluding Edge adhesives bubble: bubble Width ≤1/2 Margin width; Length ≤0.5mm。n≤5	MI	Visual / Ruler	Zone B
11	Protect film	Surface scratch but not effect protect function, Allowed		Visual Inspection	
12	Silicon glue	Thickness≤PS surface(With protect film): Full cover the IC; Shape: The width on the FPC ≤ 0.5mm (Front) The width on the FPC≤1.0mm (Back) smooth surface,No obvious raised.	MI	Visual Inspection	
13	Warp degree (TFT substrate)	t≤2.0mm	MI	Ruler	
14	Color difference in COM area (Silver point area)	Allowed		Visual Inspection	

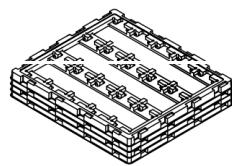
16. Packing

PACKLING ORDER:

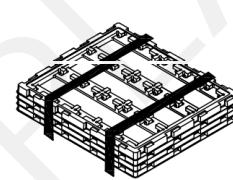
- 1) Putting 15 pcs Modules on each PET tray. And cover a dedicated EPE film.



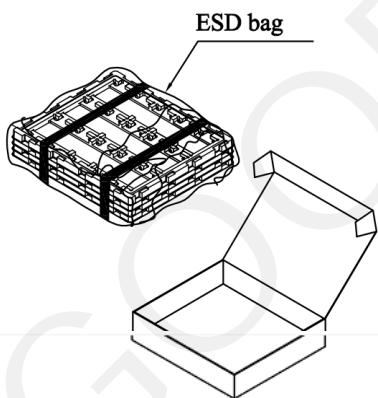
- 2) Putting 9 pcs PET trays together with 1 empty tray on the top of PET tray.



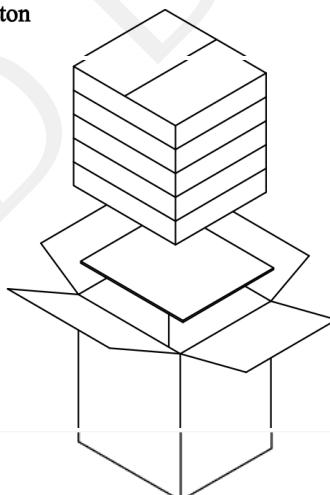
- 3) tie the tray together with rubber band



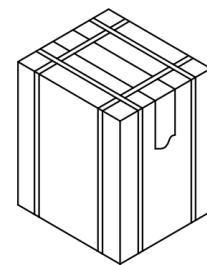
- 4) Insert in the ESD bag, add desiccant in the ESD bag, Putting in the inner small carton (TYPE:H82)



- 5) Putting 5 small cartons into one outcarton



- 6) Packing finished



Note: 15 pcs in a tray, 9 trays in a inner carton, 5 inner cartons in a out carton, so $15 \times (10-1) \times 5 = 675$ pcs/Outcarton

Dimension (Small carton): 385*325*87mm

Dimension (Out carton): 394*344*470mm

17. Precautions

- (1) Do not apply pressure to the EPD panel in order to prevent damaging it.
- (2) Do not connect or disconnect the interface connector while the EPD panel is in operation.
- (3) Do not touch IC bonding area. It may scratch TFT lead or damage IC function.
- (4) Please be mindful of moisture to avoid its penetration into the EPD panel, which may cause damage during operation.
- (5) If the EPD Panel / Module is not refreshed every 24 hours, a phenomena known as "Ghosting" or "Image Sticking" may occur. It is recommended to refreshed the ESL /EPD Tag every 24 hours in use case. It is recommended that customer ships or stores the ESL / EPD Tag with a completely white image to avoid this issue
- (6) High temperature, high humidity, sunlight or fluorescent light may degrade the EPD panel's performance. Please do not expose the unprotected EPD panel to high temperature, high humidity, sunlight, or fluorescent for long periods of time.
- (7) For more precautions, please click on the link:
<https://www.good-display.com/news/80.html>